

■ **FEATURES**

- Glass passivated junction
- For Surface Mount Applications
- Easy to pick and place
- Plastic packages have an Underswriter's Laboratory
- Flammability Classifications 94V-0
- High Temperature Soldering guaranteed: 260°C/10 seconds at terminals.
- Component in accordance to RoHS 2002/96/EC.

■ **MECHANICAL DATA**

- Case: JEDEC SMA (DO-214AC) molded plastic over glass passivated chip
- Terminals: Solder plated
- Polarity: Color band denotes cathode end.

■ **MAXIMUM RATINGS** ($T_A=25^\circ\text{C}$ Unless otherwise specified)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%

| Characteristic | Symbol | RS2AA | RS2BA | RS2DA | RS2GA | RS2JA | RS2KA | RS2MA | Unit |
|---|---------------------------------|-------|-------|-------|-------|-------|-------|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V_{RRM} V_{RWM} V_R | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ $T_T = 120^\circ\text{C}$ | I_O | 1.5 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I_{FSM} | 50 | | | | | | | A |

■ **ELECTRICAL CHARACTERISTICS** ($T_A=25^\circ\text{C}$ Unless otherwise specified)

| Characteristic | Symbol | RS2AA | RS2BA | RS2DA | RS2GA | RS2JA | RS2KA | RS2MA | Unit |
|--|----------|------------|-------|-------|-------|-------|-------|-------|---------------|
| Forward Voltage @ $I_F = 1.5\text{A}$ | V_{FM} | 1.3 | | | | | | | V |
| Peak Reverse Current @ $T_A = 25^\circ\text{C}$ at Rated DC Blocking Voltage (Note 1) @ $T_A = 125^\circ\text{C}$ | I_{RM} | 5.0 200 | | | | | | | μA |
| Reverse Recovery Time (Note 3) | t_{rr} | 150 | | | | | 250 | 500 | ns |
| Typical Total Capacitance (Note 4) | C_T | 30 | | | | | | | pF |

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
 2. Reverse recovery test conditions: $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{rr} = 0.25\text{A}$. See Figure 5.
 3. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

■ **THERMAL CHARACTERISTICS** ($T_A=25^\circ\text{C}$ Unless otherwise specified)

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Typical Thermal Resistance, Junction to Terminal (Note 5) | $R_{\theta JT}$ | 20 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -65 to +150 | $^\circ\text{C}$ |

■ **PACKAGING INFORMATION**

| Part Number | Case | Packaging |
|-------------|------|------------------|
| RS2xA | SMA | 5000/Tape & Reel |

*x = defines voltage from 50V(RS2AA) to 1000V(RS2MA) (SMA package)

- Notes:
5. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive/EC Annex Notes.
 6. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
 7. For packaging details, go to our website at <http://www.diodes.com>.

■ **RATINGS AND CHARACTERISTIC CURVES**

FIG.1-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

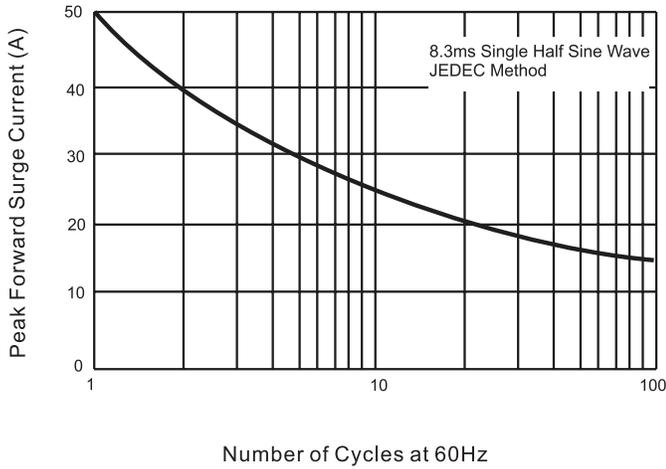


FIG.2-MAXIMUM CURRENT DERATING CURVE

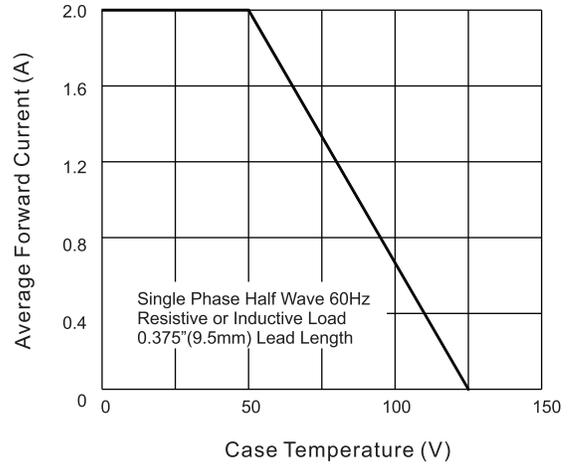


FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

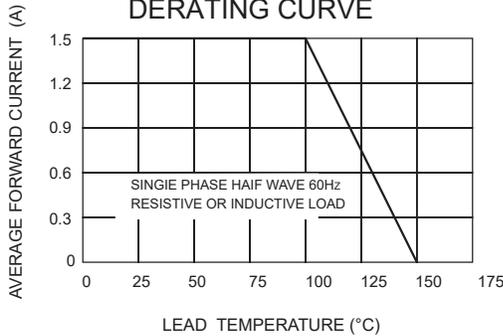
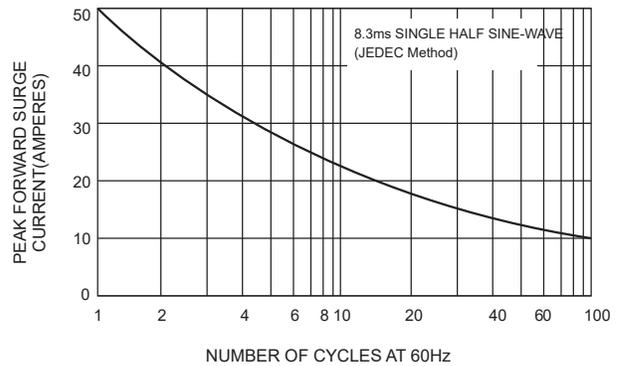


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



CHARACTERISTICS
FIG.3-TYPICAL INSTANTANEOUS FORWARD

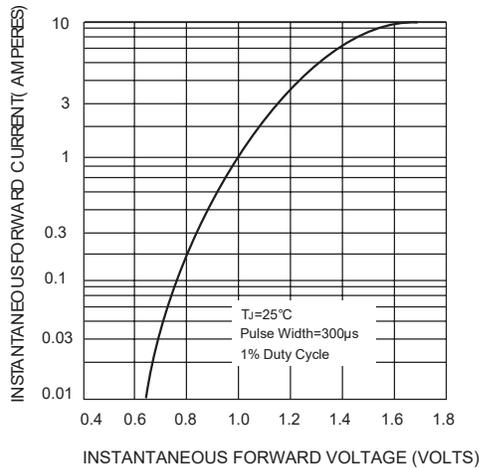


FIG.4-TYPICAL REVERSE CHARACTERISTICS

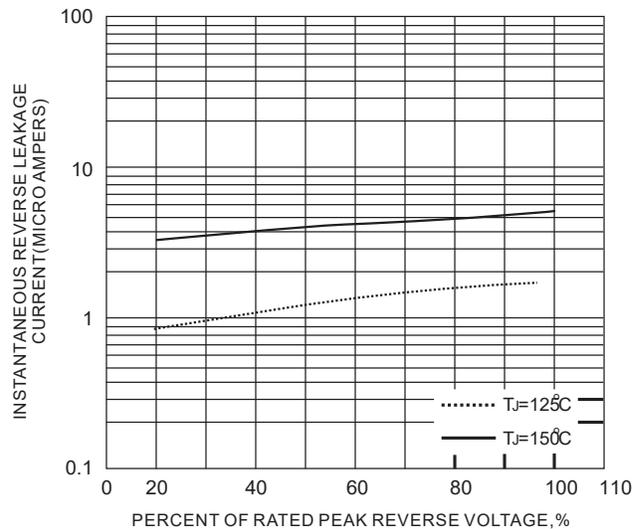


FIG.5-TYPICAL JUNCTION CAPACITANCE

■ **RATINGS AND CHARACTERISTIC CURVES (continued)**

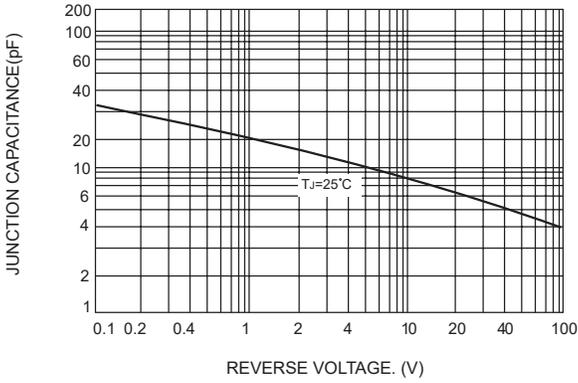
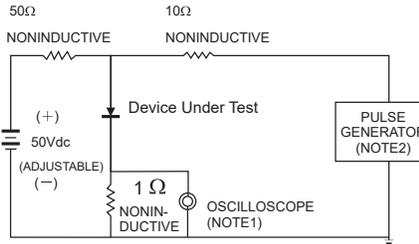
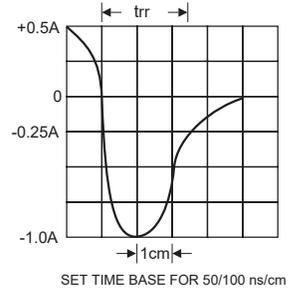


FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



NOTES: 1. Rise Time=7ns max. input Impedance=1 megohm 22pF
2. Rise Time=10ns max. source Impedance =50 ohms



■ **OUTLINE DIMENSIONS**

SMA

